

100641C

ID1300-500-.5U- 1300 MHz Dispersive Delay Line 500 MHz Bandwidth

Specifications

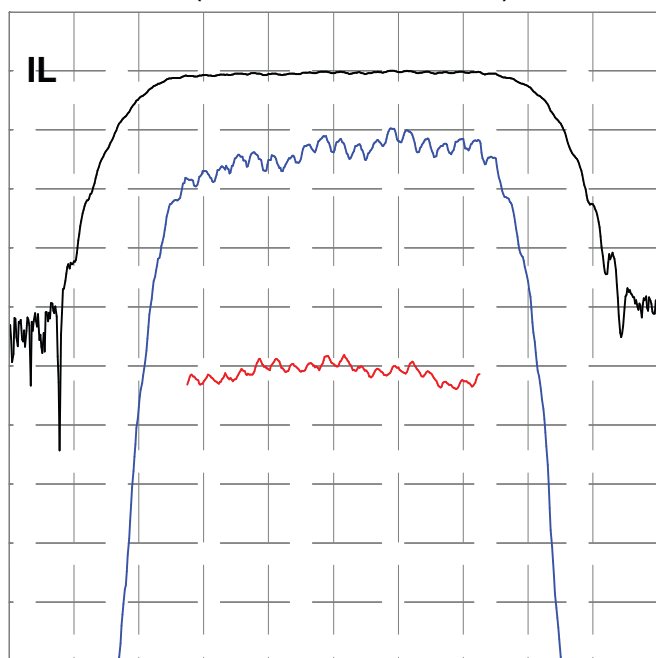
Parameter	Symbol	Min	Typical	Max	Unit
Center Frequency	F_0		1300		MHz
Bandwidth	B		500		MHz
Dispersion	T		0.5		μsec
Delay	T_0	0.845	0.848	0.85	μsec
Insertion Loss	IL		35.9	40	dB
Slope	S_0	-0.0012	-0.0012	-0.0011	$\mu\text{s}/\text{MHz}$
Pulse Width at -3dB			0.0019	0.002	μsec
Sidelobes for $ t - T_0 < T$			-14.4	-12	dB
Time Spurious for $ t - T_0 > T$			-45	-42	dB
Substrate Material		128YX-LN			

Notes

- Center Frequency (F_0) and Bandwidth (B) are defined, not measured. Dispersion (T) is defined as $|B * S_0|$.
- Insertion Loss is the minimum loss for $|f - F_0| < .5B$
- Delay and Slope determined by best fit quadratic pulse in $|f - F_0| < .5B$.
- Specifications are at 22 °C only. Unit will operate undamaged from -54 °C to 125 °C with shifts $dF_0 = -x * F_0$, $dT_0 = x * (T_0 + S_0 * F_0)$, $dS_0 = x * 2 * S_0$, where $x = 75E-6 * (\text{temperature} - 22^\circ\text{C})$

Typical Performance

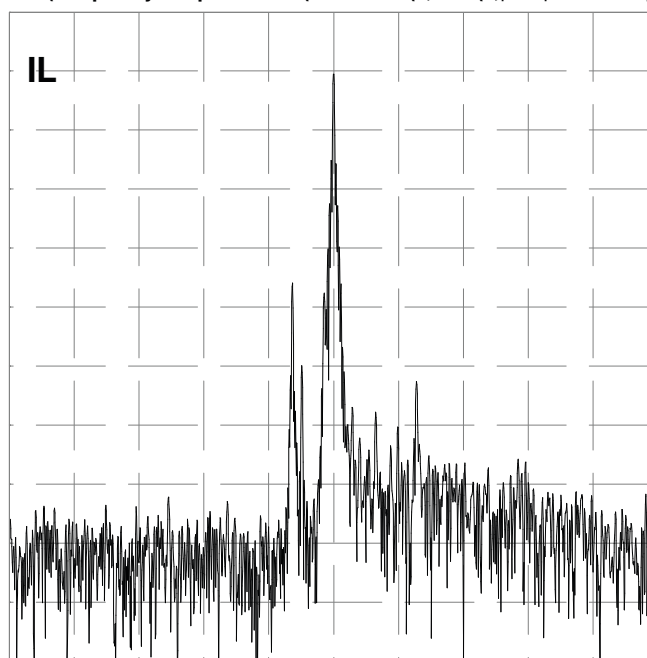
Frequency Response
(Best Fit Linear Phase Removed)



10 dB/div, 1 dB/div, 10 deg/div, 6.000 MHz/div

Impulse Response

FFT(Frequency Response * Cos(0.5 * PI * MIN(1, MAX(0, |f - F0| * 2.0 / 35 - 1.0)))^2)

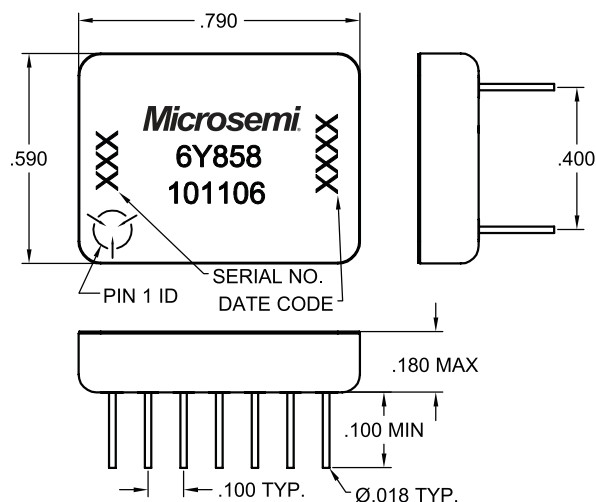


10 dB/div, 1.000 us/div

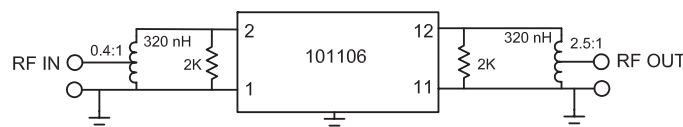
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Package Outline



Matching



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